AMENDMENTS TO THE CLAIMS

Claim 1. (Currently Amended) A modified polyoxyalkylene polyamine obtained by addition reaction of a <u>polyamine consisting essentially of polyoxyalkylene polyamine</u> and an unsaturated hydrocarbon compound.

Claim 2. (Original) The modified polyoxyalkylene polyamine according to Claim 1, wherein said polyoxyalkylene polyamine has a weight average molecular weight of not more than 1000.

Claim 3. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 1, wherein the carbon number of said unsaturated hydrocarbon compound is 2 to 16.

Claim 4. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 2, wherein the carbon number of said unsaturated hydrocarbon compound is 2 to 16.

Claim 5. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 3, wherein said unsaturated hydrocarbon compound is styrene.

Claim 6. (Currently Amended) The modified polyoxyalkylene polyamine according to Claim 4, wherein said unsaturated hydrocarbon compound is styrene.

Claim 7. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 1, wherein the molar number of modification of said polyoxyalkylene polyamine by said unsaturated hydrocarbon compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \le X \le A \tag{1}$$

wherein "A" represents the number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents the molar number of modification.

Claim 8. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 2, wherein the molar number of modification of said polyoxyalkylene polyamine by said unsaturated hydrocarbon compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \le X \le A \tag{1}$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents the molar number of modification.

Claim 9. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 3, wherein the molar number of modification of said polyoxyalkylene polyamine by said unsaturated hydrocarbon compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \le X \le A \tag{1}$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents the molar number of modification.

Claim 10. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 5, wherein the molar number of modification of said polyoxyalkylene polyamine by said unsaturated hydrocarbon compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \le X \le A \tag{1}$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents the molar number of modification.

Claim 11. (Previously Presented) The modified polyoxyalkylene polyamine according to Claim 6, wherein the molar number of modification of said polyoxyalkylene polyamine by said unsaturated hydrocarbon compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \le X \le A \tag{1}$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents the molar number of modification.

Claim 12. (Original) A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 1.

Claim 13. (Original) A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 2.

Claim 14. (Original) A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 3.

Claim 15. (Original) A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 5.

Claim 16. (Original) A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 6.

Claim 17. (Withdrawn) An epoxy resin composition comprising an epoxy resin and the curing agent for epoxy resin according to Claim 12.

Claim 18. (Withdrawn) An epoxy resin cured product obtainable by curing the epoxy resin composition according to Claim 17.